

IH61MF-Q5 Motherboard



- Socket LGA 1155
- Supported the Intel 3rd and 2nd generation Core i7/ i5/ i3 processors in the 1155 package
- Supported 2 DIMM of DDR3 1600/1333/1066MHz

Specification

CPU SUPPORT	Maximum CPU TDP (Thermal Design Power) : 95Watt
MEMORY	Support Dual Channel DDR3 1066/1333/1600 MHz 2 x DDR3 DIMM Memory Slot Max. Supports up to 16GB Memory
INTEGRATED VIDEO	By CPU model
STORAGE	4 x SATA II Connector s (3Gb/s)
LAN	Realtek RTL8111G - 10/100/1000Mb/s Controller
AUDIO CODEC	Realtek ALC662 6-Channel HD Audio
USB	4 x USB 2.0 Port 2 x USB 2.0 Header
EXPANSION SLOT	1 x PCI-E 3.0 x16 Slot(supported by Core i5 -3xxx / Core i7 3xxx CPU) 1 x PCI-E 2.0 x1 Slot
REAR I/O	1 x PS/2 Mouse 1 x PS/2 Keyboard 4 x USB 2.0 Port 1 x VGA Port 1 x LAN Port 3 x Audio Jacks
INTERNAL I/O	2 x USB 2.0 Header 4 x SATA II Connector (3Gb/s) 1 x Front Audio Header 1 x Front Panel Header 1 x CPU Fan Connector 1 x System Fan Connector 1 x COM Port Header
H/W MONITORING	CPU / System Temperature Monitoring CPU / System Fan Monitoring Smart / Manual CPU Fan Control System Voltage Monitoring
DIMENSION	Micro ATX Form Factor Dimension: 19.1cm x 17cm (W x L)

OS SUPPORT	Supports Windows XP / Vista / 7 / 8
BUNDLE SOFTWARE	BIO-Remote2
ACCESSORIES	2 x SATA Cable 1 x I/O Shield 1 x DVD Driver 1 x Quick Guide
FEATURES	BIO-FLASHER Supports Charger Booster Supports BIOS Online Update

OVERVIEW

	Intel H61 chipset The Intel® H61 Express Chipset is a single-chipset design to support the new 1155 socket Intel® 3rd/2nd Generation Core™ i7 / Core™ i5 / Core™ i3 / Pentium® / Celeron® processors. It provides improved performance by utilizing serial point-to-point links, which allows increased bandwidth and stability.
	HD Audio Provides high quality sound with minimal loss of audio fidelity.
	DX11 Direct3D 11 enables Direct3D 10 APIs and Direct3D 11 APIs to use one underlying rendering device. And it allows developers to achieve a high speed, fully conformant software rasterizer.
	PCIe 3.0 PCIe 3.0 is the ubiquitous and general-purpose PCI Express I/O standard. At 8GT/s bit rate, the interconnect performance bandwidth is doubled over PCIe 2.0, while preserving compatibility with software and mechanical interfaces.
	Dual DDR3-1600 It supports 2 or 4 DIMM Slots DDR3 memory that features data transfer rates of DDR3 1600/1333. The processor support 2 memory channels and setting the memory multiplier, allows selection of the channel speed. These clearly uplift the band width and boost the overall system performance.
	ESD Protection ESD (Electrostatic Discharge) is the major factor to destroy the PC by electrical overstress (EOS) condition. ESD occurred by PC users when touch any devices connect to a PC, which may result in damage to the motherboard or parts. ESD protection is designed to protect the motherboard and equipment from damage by EOS.
	USB Polyswitch On board dedicated power fuse to help prevent USB port failure. It prevents USB Port overcurrent and safe guard your system and device lifespan.



OC / OV / OH Protection

OC / OV / OH Protection design detects overvoltage conditions and prevents voltage surges from spreading in real time. It also actively cuts off the overvoltage supply to protect your system.

*The specification and pictures are subject to change without notice and the package contents may differ by area or your motherboard version!



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